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Lucica Lu	EMERGING DISPLAY	ISSUE : APR.01, 2019
OVED BY:	TECHNOLOGIES CORPORATION	TOTAL PAGE: 24
Vincent Uh		VERSION: 3
CUSTOMER	ACCEPTANCE SPEC	CIFICATIONS
FOR	DEL NO.: ET050013DMA (RoHS) MESSRS:	Septiation. Septiation.

EMERG	INC DI	ICDIAV	MODEL NO.	VERSION	PAGE
	OGIES CORF		ET050013DMA	3	0-1
			DOC . FIRST ISSUE		
RECORD		EVISION		JA	AN.31, 2019
DATE	REVISED PAGE NO.		SUMMARY		
MAR.07, 2019	1		SPECIFICATIONS LREA: 110W * 66.8H mm→109.8W * 60	5.6H mm	
	9		IENSIONS DIFY FRAME OPENING & POLARIZI DIFY FPC OUTLINE DIMENSION	ER	
APR.01, 2019	1	2. MECHANICAL	SPECIFICATIONS AREA: 109.8W * 66.6H mm→110W * 60	6.8H mm	>
	9	7. OUTLINE DIM	IENSIONS DIFY POLARIZER AND ADD INSUL.	0,	& PULL
		Display of the Principle of the Principl	edinologies corporations. Edinologies corporations Edinologies corpo		>°

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1. GENERAL SPECIFICATIONS

1.1 DATA SHEETS FOR CONTROLLER/DRIVER PLEASE REFER TO:

SITRONIX ST7262

1.2 MATERIAL SAFETY DESCRIPTION
ASSEMBLIES SHALL COMPLY WITH EUROPEAN ROHS REQUIREMENTS,
INCLUDING PROHIBITED MATERIALS/COMPONENTS CONTAINING LEAD,
MERCURY, CADMIUM, HEXAVALENT CHROMIUM, POLYBROMINATED
BIPHENYLS (PBB) AND POLYBROMINATED
DIPHENYL ETHERS (PBDE), BIS(2-ETHYLHEXYL) PHTHALATE (DEHP), BUTYL
BENZYL PHTHALATE (BBP), DIBUTYL PHTHALATE (DBP), DIISOBUTYL
PHTHALATE (DIBP).

2. MECHANICAL SPECIFICATIONS

(1)DIAGONALS	-5.0 inch
(2) NUMBER OF DOTS	800W * (RGB) * 480H DOTS
(3) MODULE SIZE	118.5W * 77.55H *2.8D mm (WITHOUT FPC)
(4) VIEWING AREA	-110W * 66.8H mm
(5) ACTIVE AREA	108W * 64.8H mm
(6)DOT SIZE	0.045W * 0.135H mm
(7) PIXEL SIZE	0.135W * 0.135H mm
(8)LCD TYPE	-TFT, TRANSMISSIVE, NORMALLY BLACK
(9)COLOR	-16.7M
(10) VIEWING DIRECTION	SUPER WIDE VIEW
(11)BACK LIGHT	LED, COLOR : WHITE
(12)INTERFACE MODE	RGB 24 BIT PARALLEL
	(DE/SYNC MODE)
60	
Y Y	

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3. ABSOLUTE MAXIMUM RATINGS

3.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS.

ITEM	SYMBOL	MIN.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD-VSS	-0.3	4.0	V	
INPUT SIGNAL VOLTAGE	VIN-VSS	- 0.3	4.0	V	
STATIC ELECTRICITY	_			V	NOTE(1)
FOG POWER DISSIPATION	PD_FOG		(0.345)	W	
LED BACKLIGHT POWER DISSIPATION	PD	_	(1687)	mW	8
LED BACKLIGHT FORWARD CURRENT	IF	> –	(70)	mA	507
LED BACKLIGHT REVERSE VOLTAGE	VR	_	(35)	V	×10°C

NOTE (1): LCM SHOULD BE GROUNDED DURING HANDLING LCM.

3.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS.

ITEM	OPERATING		STORAGE		REMARK	
HEM	MIN.	MAX.	MIN.	MAX.	KEWAKK	
AMBIENT TEMPERATURE	-20°C	70°C	-30°C	80°C	NOTE(1),(2)	
HUMIDITY	NOTE	E(3)	NOT	E (3)	WITHOUT	
HOMIDIT I	YNOTI	3(3)	NOTE(3)		CONDENSATION	
VIBRATION		2.45 m/s^2		11.76 m/s^2	10~55Hz	
VIBRATION		(0.25 G)		(1.2 G)	X,Y,Z, EACH 2HRS	
	Á	29.4 m/s ²	XO	490 m/s ²	6 ms	
SHOCK		(3G)	~ —	(50 G)	XYZ DIRECTIONS	
	.67	(30)		(300)	3 TIMES EACH	
CORROSIVE GAS	NOT ACC	EPTABLE	NOT ACC	EPTABLE		

NOTE (1): Ta AT -30°C: WILL BE 48HRS MAX.

80°C: WILL BE 168HRS MAX.

NOTE (2): BACKGROUND COLOR CHANGES SLIGHTLY DEPENDING ON AMBIENT

TEMPERATURE THIS PHENOMENON IS REVERSIBLE .

NOTE (3): $Ta \le 60^{\circ}C : 90\% RH MAX (96HRS MAX)$.

Ta > 60°C : ABSOLUTE HUMIDITY MUST BE LOWER THAN THE HUMIDITY

OF 90% RH AT 60°C(96HRS MAX).

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4. ELECTRICAL CHARACTERISTICS

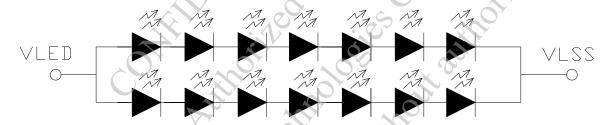
 $Ta = 25 \, ^{\circ}C$

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT	REMARK
POWER SUPPLY VOLTAGE	VDD-VSS	_	3.15	3.30	3.45	V	
INPUT HIGH VOLTAGE	VIH		0.7*VDD		VDD	V	NOTE (1)
INPUT LOW VOLTAGE	VIL		VSS		0.3*VDD	V	NOTE (1)
OUTPUT HIGH VOLTAGE	VOH	_	VDD-0.4	_	VDD	V	NOTE (1)
OUTPUT LOW VOLTAGE	VOL	_	VSS	_	VSS+0.4	V	NOTE (1)
POWER SUPPLY CURRENT	IDD	_		(80)	(100)	mA	NOTE (2)
POWER SUPPLY FOR LED BACKLIGHT	VLED-VLSS	IF = 40mA	(18.5)	(23.1)	(24.1)	V	NOTE (3)
LED LIFE TIME	_	IF = 40mA	(30000)	(40000)	10	HOURS	NOTE (5) NOTE (6)

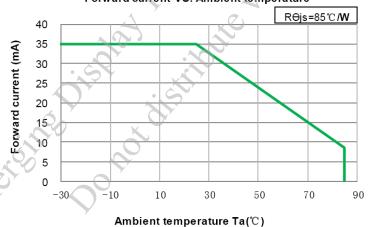
NOTE (1): APPLIED TO TERMINALS, DR0~DR7, DG0~DG7, DB0~DB7, DCLK, STBYB, HSYNC, VSYNC,

NOTE (2): THE DISPLAY PATTERN IS ALL "WHITE".

NOTE (3): INTERNAL CIRCUIT DIAGRAM OF BACKLIGHT



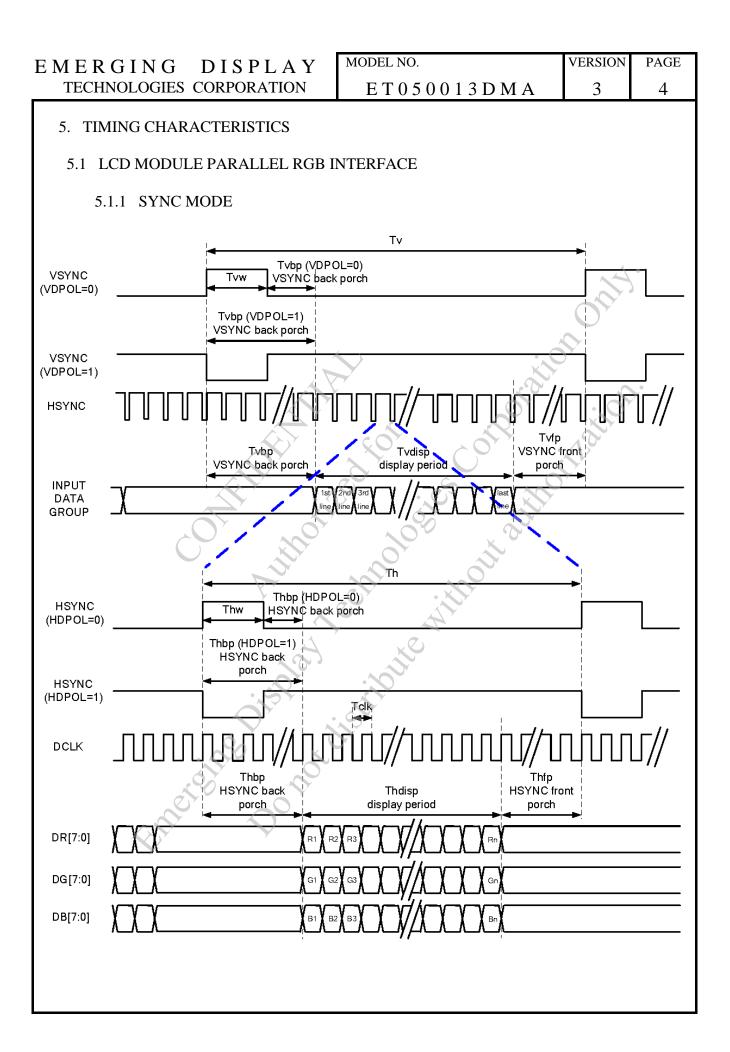
NOTE (4): AMBIENT TEMP. VS. ALLOWABLE FORWARD CURRENT.(PER LED) Forward current VS. Ambient temperature



NOTE (5): CONDITIONS; TA=25 °C, CONTINUOUS LIGHTING.

NOTE (6): DEFINITIONS OF LIFE TIME:

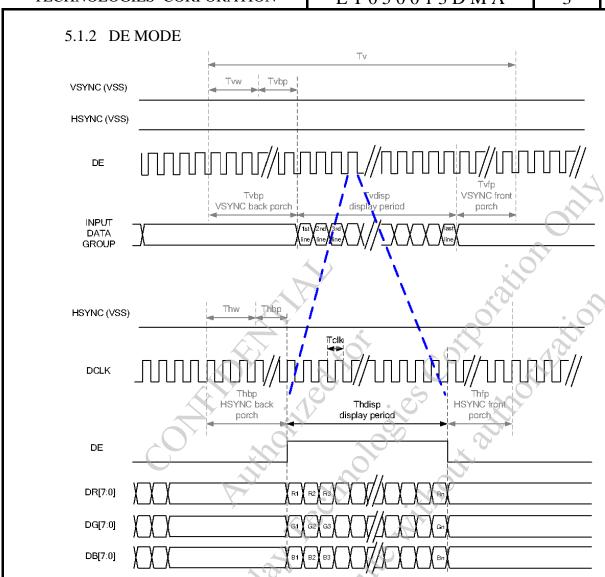
LCM LUMINANCE BECOMES HALF OF THE INITIAL VALUE.



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5.1.3 TIMING TABLE

	ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
DCLK FREQ	UENCY	Fclk	25	25	27	MHz
	PERIOD TIME	Th	808	816	896	DCLK
	DISPLAY PERIOD	Thdisp	800	800	800	DCLK
HSYNC	BACK PORCH	Thbp	4	8	48	DCLK
	FRONT PORCH	Thfp	4	8	48	DCLK
	PULSE WIDTH	Thw	2	4	6	DCLK
y	PERIOD TIME	Tv	488	496	504	HSYNC
	DISPLAY PERIOD	Tvdisp	480	480	480	HSYNC
VSYNC	BACK PORCH	Tvbp	4	8	12	HSYNC
	FRONT PORCH	Tvfp	4	8	12	HSYNC
	PULSE WIDTH	Tvw	2	4	8	HSYNC

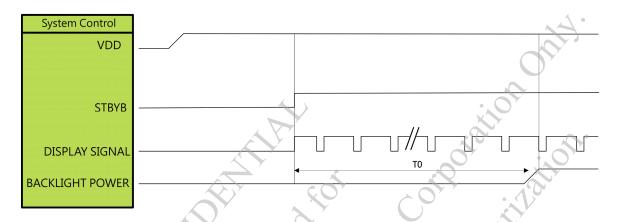
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5.2 LCD MODULE POWER ON-OFF TIMING SEQUENCE

5.2.1 POWER ON SEQUENCE

SYMBOL	DESCRIPTION	MIN. TIME	UNIT
T0	DISPLAY SIGNAL OUTPUT TO BACKLIGHT POWER ON	250	ms

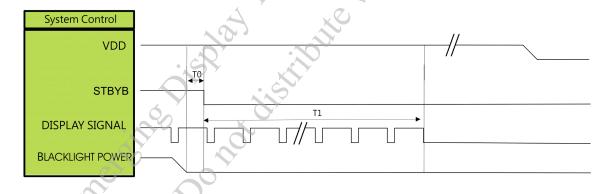
NOTE: RGB INTERFACE DISPLAY SIGNAL: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]



5.2.2 POWER OFF TIMING SEQUENCE

SYMBOL	DESCRIPTION	MIN. TIME	UNIT
T0	BACKLIGHT POWER OFF TO DISP="LOW"	5	ms
T2	DISP="LOW" TO IC INTERNAL VOLTAGE DISCHARGE COMPLETE	100	ms

NOTE: RGB INTERFACE DISPLAY SIGNAL: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]



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6. OPTICAL CHARACTERISTICS

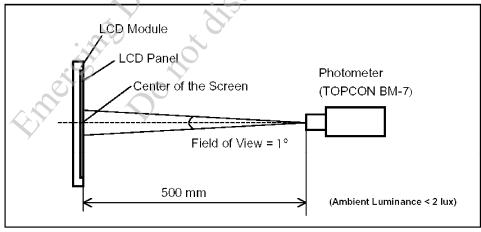
6.1 OPTICAL CHARACTERISTICS (NOTE 1)

 $Ta=25\pm2$ °C

ITEM		SYMBOL	CON	DITION	MIN.	TYP.	MAX.	UNIT	REMARK	
		θ_{y}		$\theta_x=0^{\circ}$	(70)	(80)	_			
VIEWING ANGLI	VIEWING ANGLE		CR ≥	O _X -O	(70)	(80)		deg.	NOTE (2)	
VILWING ANGLE		θ_{x^+}	10	10	10 θ _v =0°	(70)	(80)		ucg.	NOTE (3)
		θ_{x}		0 _y -0	(70)	(80)		_ ^	\Box	
CONTRAST RATIO (CENTER)		CR	$\theta x=0^{\circ}$, θy=0°	(800)	(1000)			NOTE (3)	
RESPONSE TIME	,	TR(rise)+TF(fall)	$\theta x=0^{\circ}$, θy=0°		(30)	(40)	msec	NOTE (4)	
	WHITE	Wx	1		(0.275)	(0.325)	(0.375)			
	WHILE	Wy			(0.298)	(0.348)	(0.398)		€.	
COLOR OF	RED	Rx	<i>y</i>		(0.570)	(0.620)	(0.670)	: (D,	
CIE		Ry	$\theta x=0^{\circ}$, θy=0°	(0.278)	(0.328)	(0.378)		NOTE (5)	
COORDINATE	GREEN	Gx	IF=	40mA	(0.284)	(0.334)	(0.384)		NOTE (3)	
(CENTER)		Gy			(0.494)	(0.544)	(0.594)	y —		
	BLUE_	Bx	.10		(0.086)	(0.136)	(0.186)			
	BLUE	By			(0.093)	(0.143)	(0.193)			
THE BRIGHTNESS OF		В	$\theta x=0^{\circ}$, θy=0°	(450)	(500)	2	cd/m²	NOTE (6)	
MODULE (CENTER)		В		40mA	(430)	(300)		Cu/III	140112 (0)	
THE UNIFORMIT MODULE	Y OF			, θy=0° 40mA	(70)	<u> </u>		%	NOTE (7)	

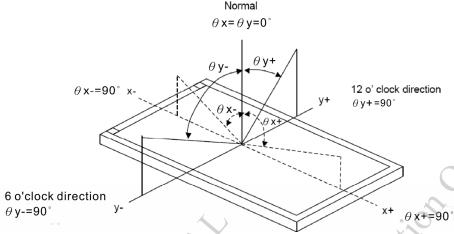
NOTE (1): TEST EQUIPMENT SETUP:

AFTER STABILIZING AND LEAVING THE PANEL ALONE AT A GIVEN TEMPERATURE FOR 30 MINUTES, THE MEASUREMENT SHOULD BE EXECUTED. MEASUREMENT SHOULD BE EXECUTED IN A STABLE, WINDLESS, AND DARK ROOM. OPTICAL SPECIFICATIONS ARE MEASURED BY TOPCON BM-7 (FAST) WITH A VIEWING ANGLE OF 1° AT A DISTANCE OF 50cm AND NORMAL DIRECTION.



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NOTE (2): DEFINITION OF VIEWING ANGLE:



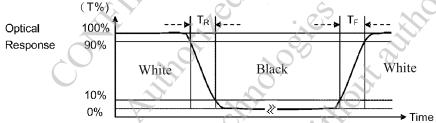
NOTE (3): DEFINITION OF CONTRAST RATIO (CR):

MEASURED AT THE CENTER POINT OF MODULE

 $CONTRAST \quad RATIO(CR) = \frac{BRIGHTNESS \; MEASURED \; WHEN \; LCD \; IS \; AT \; "WHITE \; STATE"}{BRIGHTNESS \; MEASURED \; WHEN \; LCD \; IS \; AT \; "BLACK \; STATE"}$

NOTE (4) : DEFINITION OF RESPONSE TIME : T_R AND T_F

THE FIGURE BELOW IS THE OUTPUT SIGNAL OF THE PHOTO DETECTOR.



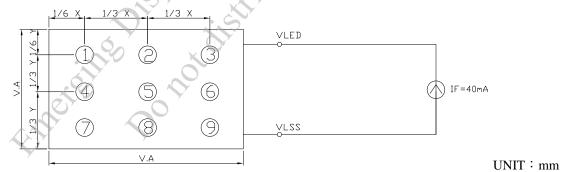
NOTE (5): DEFINITION OF COLOR CHROMATICITY

(a)100% RGB PIXEL DATA TRANSMISSION WHEN ALL THE INPUT TERMINALS OF MODULE ARE ELECTRICALLY POWERED ON.

(b)MEASURED AT THE CENTER POINT OF MODULE

NOTE (6): MEASURED THE BRIGHTNESS OF WHITE STATE AT CENTER POINT.

NOTE (7): (a) DEFINITION OF BRIGHTNESS UNIFORMITY

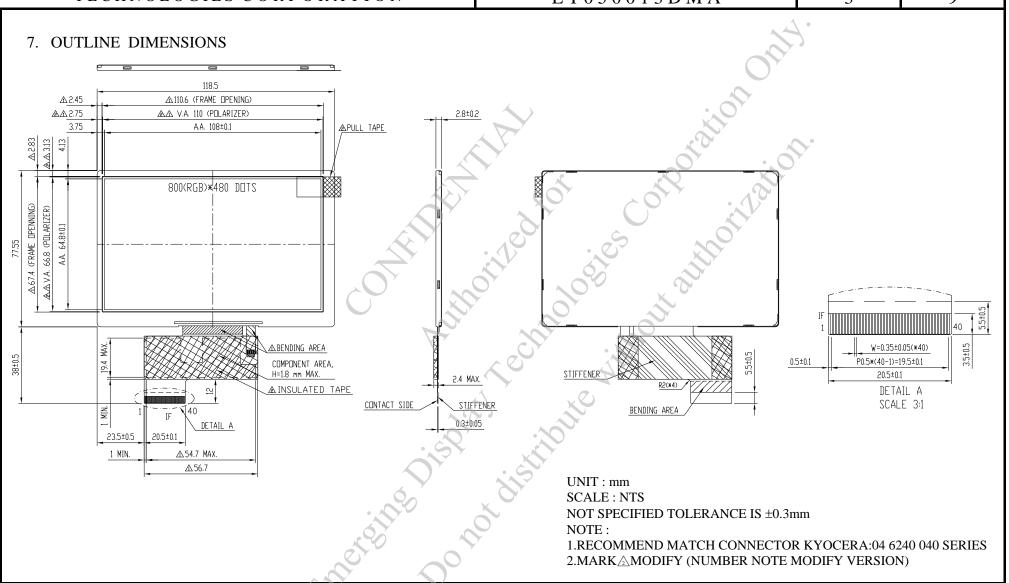


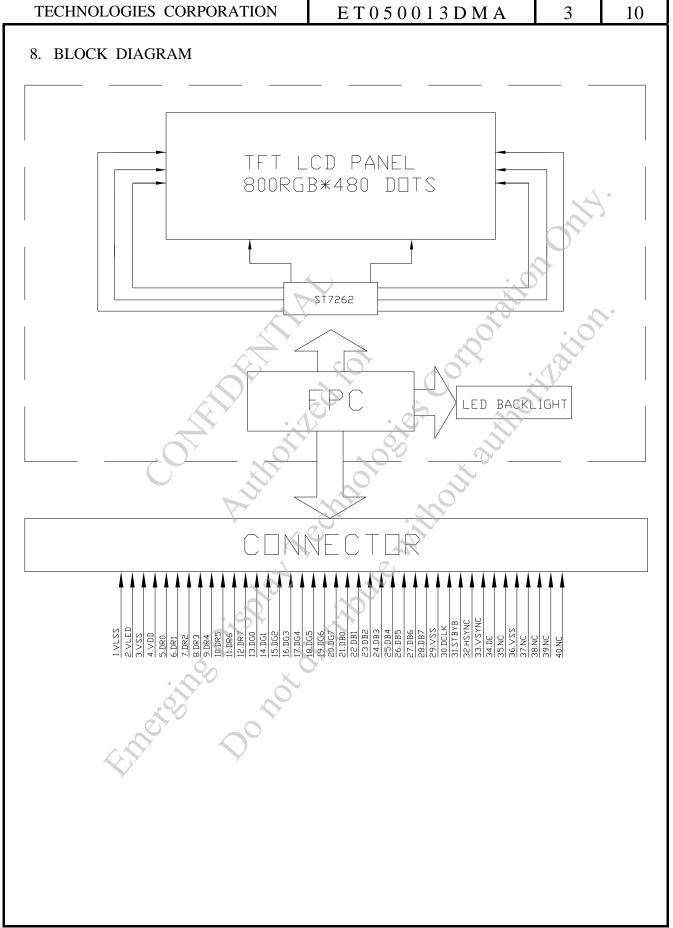
(b)THE BRIGHTNESS UNIFORMITY CALCULATING METHOD

UNIFORMITY: $\frac{\text{MINIMUM BRIGHTNESS}}{\text{MAXIMUM BRIGHTNESS}} *100\%$

E M E R G I N G D I S P L A Y TECHNOLOGIES CORPORATION

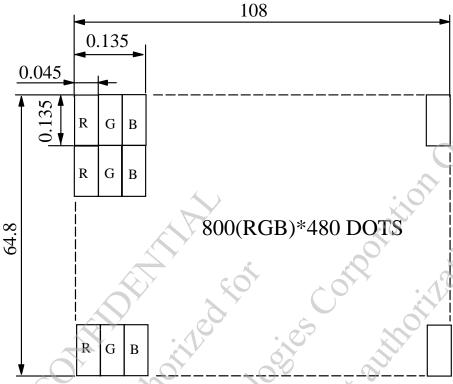
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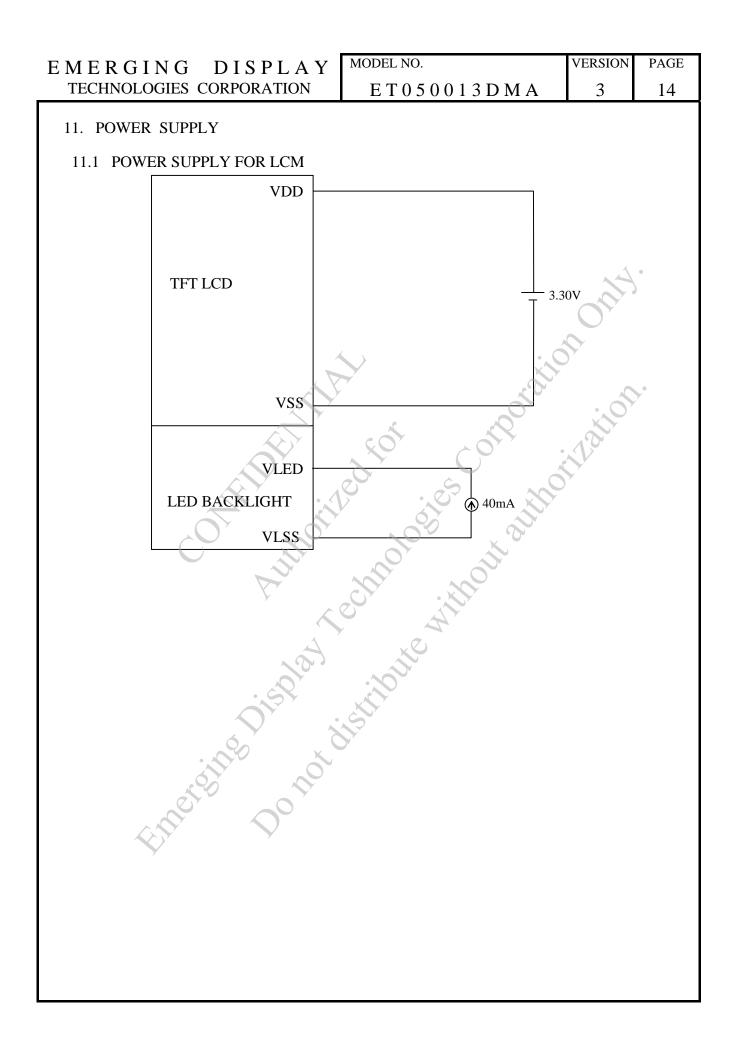
UNIT: mm
SCALE: NTS
NOT SPECIFIED TOLERANCE IS ± 0.1
DOTS MATRIX TOLERANCE IS ± 0.01

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10. INTERFACE SIGNALS

PIN NO.	SYMBOL	FUNCTION
1	VLSS	POWER SUPPLY FOR LED BACKLIGHT (CATHODE SIDE)
2	VLED	POWER SUPPLY FOR LED BACKLIGHT (ANODE SIDE)
3	VSS	GROUND
4	VDD	POWER SUPPLY VOLTAGE
5	DR0	
6	DR1	
7	DR2	
8	DR3	DISPLAY DATA (R)
9	DR4	DR0 LSB DR7 MSB
10	DR5	The state of the s
11	DR6	
12	DR7	
13	DG0	
14	DG1	(\$ 10°) (\$ 10°)
15	DG2	
16	DG3	DIŠPLAY DATA (G) DG0 LSB
17	DG4	DG0 LSB DG7 MSB
18	DG5	
19	DG6	
20	DG7	4
21	DB0	A
22	DB1	
23	DB2	
24	DB3	DISPLAY DATA (B) DB0 LSB
25	DB4	DB7 MSB
26	DB5	
27	DB6	
28	DB7	
29	VSS	GROUND
30	DCLK	CLOCK SIGNAL FOR DATA LATCHING AND INTERNAL COUNTER OF THE TIMING CONTROLLER
31	STBYB	STANDBY MODE CONTROL SIGNAL LO: TCON AND SOURCE DRIVER ARE OFF HI : ALL THE FUNCTIONS ARE ON

32 33		FUNCTION
33	HSYNC	HORIZONTAL SYNC SIGNAL
	VSYNC	VERTICAL SYNC SIGNAL
34	DE	INPUT DATA ENABLE CONTROL, WHEN DE MODE, ACTIVE HIGH TO ENABLE DATA INPUT, NORMALLY PULL LOW
35	NC	NON CONNECTION
36	VSS	GROUND
37	NC	NON CONNECTION
38	NC	NON CONNECTION
39	NC	NON CONNECTION
40	NC	NON CONNECTION
		NON CONNECTION OF CHILD IN THE CONTROL OF CO



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12. INSPECTION CRITERION

12.1 APPLICATION

THIS INSPECTION STANDARD IS TO BE APPLIED TO THE LCD MODULE DELIVERED FROM EMERGING DISPLAY TECHNOLOGIES CORP.(E.D.T) TO CUSTOMERS

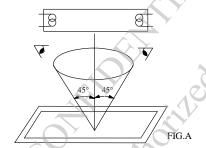
12.2 INSPECTION CONDITIONS

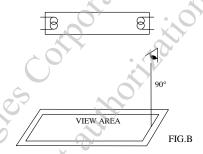
12.2.1 (1)OBSERVATION DISTANCE: 45±5cm

(2) VIEWING ANGLE: ±45°

±45° (FOR SECTION WITHIN VIEWING AREA), REFER TO FIG.A 90° (FOR SECTION OUTSIDE OF VIEWING AREA), REF TO FIG.B PERPENDICULAR TO MODULE SURFACE

VIEWING ANGLE SHOULD BE SMALLER THAN 45°





THE INSPECTION CRITERIA IS ACCORDING TO LINE OF SIGHT. INSPECTION SHALL BE MADE WITHIN THE HALF SECTION OF THE VIEWING CONE GENERATED BY LINE SEGMENT OF 45° WITH RESPECTS TO THE VERTICAL AXIS FROM CENTER VERTEX OF LCD, THE FLUORESCENT LAMP AND THE CONE AXIS MUST BE PERPENDICULAR TO THE LCD SURFACE.

IF THE DEFECTS ARE OUTSIDE OF VIEWING AREA, IT SHALL BE INSPECTED BY 90° WITH RESPECTS TO THE VERTICAL AXIS FROM EDGE OF VIEWING AREA.

12.2.2 ENVIRONMENT CONDITIONS:

AMBIEN	25±5°C	
AMBI	$65 \pm 20\%$ RH	
AMBIENT	COSMETIC INSPECTION	600~800 lux
ILLUMINATION	FUNCTIONAL INSPECTION	300~500 lux
INSP	10 secs	

12.2.3 INSPECTION LOT

QUANTITY PER DELIVERY LOT FOR EACH MODEL

12.2.4 INSPECTION METHOD

A SAMPLING INSPECTION SHALL BE MADE ACCORDING TO THE FOLLOWING PROVISIONS TO JUDGE THE ACCEPTABILITY

(a)APPLICABLE STANDARD:

ANSI/ ASQ Z1.4 NORMAL INSPECTION LEVEL II

(b)AQL: MAJOR DEFECT: AQL 0.65 MINOR DEFECT: AQL 1.0

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12.3 INSPECTION STANDARDS

12.3.1 VISUAL DEFECTS CLASSIFICATION

TYPE OF DEFECT	INSPECTION ITEM	DEFECT FEATURE	AQL
	1.DISPLAY ON	DEFECT TO MISS SPECIFIED DISPLAY FUNCTION, FOR ALL AND SPECIFIED DOTS EX: DISCONNECTION, SHORT CIRCUIT ETC	0.55
MAJOR DEFECT	2.BACKLIGHT	NO LIGHT FLICKERING AND OTHER ABNORMAL ILLUMINATION	0.65
	3.DIMENSIONS	 SUBJECT TO INDIVIDUAL ACCEPTANCE SPECIFICATIONS 	> °
MINOR DEFECT	1.DISPLAY ZONE 2.BEZEL ZONE 3.SOLDERING 4.DISPLAY ON (ALL ON)	 BLACK/WHITE SPOT BUBBLES ON POLARIZER NEWTON RING BLACK/WHITE LINE SCRATCH CONTAMINATION UNEVEN COLOR SPREAD STAINS SCRATCHES FOREIGN MATTER INSUFFICIENT SOLDER SOLDERED IN INCORRECT POSITION CONVEX SOLDERING SPOT SOLDER BALLS SOLDER SCRAPS LIGHT LINE 	1.0

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12.3.2 MODULE DEFECTS CLASSIFICATION

NO.	ITEM	CRIT	ERIA		
1.	DISPLAY ON INSPECTION	(1)INCORRECT PATTERN (2)MISSING SEGMENT (3)DIM SEGMENT (4)OPERATING VOLTAGE BEYOND			
2.	OVERALL DIMENSIONS	(1)OVERALL DIMENSION BEYOND	(1)OVERALL DIMENSION BEYOND SPEC		
3.	DOT DEFECT	(1) INSPECTION PATTERN: FULL WI AND BLUE SCREENS. (2) ITEMS BRIGHT DOT DARK DOT TOTAL BRIGHT AND DARK DOTS NOTE: 1. THE DEFINITION OF DOT: THE SIZE OF A DEFECTIVE DOT OR REGARDED AS ONE DEFECTIVE I 2. BRIGHT DOT: DOTS APPEAR BRIGHT AND UNCE PANEL IS DISPLAYING UNDER BI 3. DARK DOT: DOTS APPEAR DARK AND UNCH PANEL IS DISPLAYING UNDER PI	N ≤ 2 N ≤ 3 N ≤ 4 OVER 1/2 OF WHOLE DOT. HANGED IN SIZE IN LACK PATTERN. ANGED IN SIZE IN W	DOT IS WHICH LCD	
4.	FOREIGN BLACK/WHITE/ BRIGHT LINE/ SCRATCH OF VIEWING AREA		PERMISSIBLE NO. IGNORE 4 NONE		
5.	FOREIGN MATTER \ BLACK SPOTS \ WHITE SPOTS \ DENT (INCLUDING LIGHT LEAKAGE DUE TO POLARIZING PLATES PINHOLES, ETC.)		NUMBER OF PIECES IGNORE 4 NONE		

NO.	ITEM	CRITERIA			
			AVERAGE DIAMETER (mm): D	NUMBER OF PIECES PERMITTED	
		DUDDLE ONTHE	D ≤ 0.25	LGNORE	
		BUBBLE ON THE POLARIZER	$0.25 < D \le 0.5$	N ≤ 5	
		I OLAKIZEK	0.5 < D	NONE	
		SURFACE STAINS	D < 0.1	IGNORE	
		Bertified Straits	$0.1 < D \le 0.3$	N ≤ 3	
		CF FAIL / SPOT	D < 0.1 $0.1 < D \le 0.3$	IGNORE N≤3	
6.	BUBBLES OF POLARIZER /DIRT/CF FAIL /SURFACE STAINS	NOTE: (1)POLARIZER BUBBLE IS DEFINED AS THE BUBBLE APPEARS ON ACTIVE DISPLAY AREA. THE DEFECT OF POLARIZER BUBBLE SHALL BE IGNORED IF THE POLARIZER BUBBLE APPEARS ON THE OUTSIDE OF ACTIVE DISPLAY AREA. (2)THE EXTRANEOUS SUBSTANCE IS DEFINED AS IT CAN BE OBSERVED WHEN THE MODULE IS POWER ON. (3)THE DEFINITION OF AVERAGE DIAMETER, D IS DEFINED AS FOLLOWING. AVERAGE DIAMETER (D)=(a+b)/2 b b			
7.	LINE DEFECT ON DISPLAY	OBVIOUS VERTICAL	OR HORIZONTAL LINE	DEFECT IS NOT ALLOWED	
8.	MURA ON DISPLAY	T'S OK IF MURA IS SLIGHT VISIBLE THROUGH 6% ND FILTER			
9.	UNEVEN COLOR SPREAD, COLORATION	(1)TO BE DETERMINED BASED UPON THE STANDARD SAMPLE.			
10.	BEZEL APPEARANCE	(1)BEZEL MAY NOT HAVE RUST, BE DEFORMED OR HAVE FINGER PRINTS STAINS OF OTHER CONTAMINATION. (2)BEZEL MUST COMPLY WITH JOB SPECIFICATIONS.			
11	PCB PCB	THE SEAL AREA (THAN THREE PLA (2)NO OXIDATION O (3)PARTS ON PCB MI CHARACTERISTIC THERE SHOULD B PARTS. (4)THE JUMPER ON T CHARACTERISTIC (5)IF SOLDER GETS (R CONTAMINATION PCE UST BE THE SAME AS ON CCHART. E NO WRONG PARTS, MI	E SHOULD BE NO MORE B TERMINALS. N THE PRODUCTION ISSING PARTS OR EXCESS ORM TO THE PRODUCT ED PAD, ZEBRA PAD OR	

NO.	ITEM	CRITERIA
		(1)NO SOLDERING FOUND ON THE SPECIFIED PLACE
		(2)INSUFFICIENT SOLDER
		(a)LSI, IC
		A POOR WETTING OF SOLDER IS BETWEEN LOWER BEND OR "HEEL" OF LEAD AND PAD
		HEEL OF LEAD AND FAD
		SOLDER FILLET
		4) CHIP COMPONENT
		(b)CHIP COMPONENT · SOLDER IS LESS THAN 50% OF SIDES AND FRONT FACE
		WETTING
		SOLDER FILLET
		SOLDER FILLET
		1/2 y
		• SOLDER WETS 3 SIDES OF TERMINAL, BUT LESS THAN 25% OF
12.	SOLDERING	SIDES AND FRONT SURFACE AREA ARE COVERED
		SOLDER
	,	(3)PARTS ALIGNMENT
	6	(a)LSI, IC
		LEAD WIDTH IS MORE THAN 50% BEYOND PAD OUTLINE
	6	

	†	
NO.	ITEM	CRITERIA
		(b)CHIP COMPONENT COMPONENT IS OFF CENTER, AND MORE THAN 50% OF THE LEADS IS OFF THE PAD OUTLINE
12.	SOLDERING	
		(4)NO UNMELTED SOLDER PASTE MAY BE PRESENT ON THE PCB. (5)NO COLD SOLDER JOINTS, MISSING SOLDER CONNECTIONS, OXIDATION OR ICICLE. (6)NO RESIDUE OR SOLDER BALLS ON PCB. (7)NO SHORT CIRCUITS IN COMPONENTS ON PCB.
13.	BACKLIGHT	(1)NO LIGHT (2)FLICKERING AND OTHER ABNORMAL ILLUMINATION (3)SPOTS OR SCRATCHES THAT APPEAR WHEN LIT MUST BE JUDGED USING LCD SPOT, LINES AND CONTAMINATION STANDARDS. (4)BACKLIGHT DOESN'T LIGHT OR COLOR IS WRONG.
14.	GENERAL APPEARANCE	 (1)NO OXIDATION, CONTAMINATION, CURVES OR, BENDS ON INTERFACE PIN (OLB) OF TCP. (2)NO CRACKS ON INTERFACE PIN (OLB) OF TCP. (3)NO CONTAMINATION, SOLDER RESIDUE OR SOLDER BALLS ON PRODUCT. (4)THE IC ON THE TCP MAY NOT BE DAMAGED, CIRCUITS. (5)THE UPPERMOST EDGE OF THE PROTECTIVE STRIP ON THE INTERFACE PIN MUST BE PRESENT OR LOOK AS IF IT CAUSE THE INTERFACE PIN TO SEVER. (6)THE RESIDUAL ROSIN OR TIN OIL OF SOLDERING (COMPONENT OR CHIP COMPONENT) IS NOT BURNED INTO BROWN OR BLACK COLOR. (7)SEALANT ON TOP OF THE ITO CIRCUIT HAS NOT HARDENED. (8)PIN TYPE MUST MATCH TYPE IN SPECIFICATION SHEET. (9)LCD PIN LOOSE OR MISSING PINS. (10)PRODUCT PACKAGING MUST THE SAME AS SPECIFIED ON PACKAGING SPECIFICATION SHEET. (11)PRODUCT DIMENSION AND STRUCTURE MUST CONFORM TO PRODUCT SPECIFICATION SHEET. (12)THE APPEARANCE OF HEAT SEAL SHOULD NOT ADMIT ANY DIRT AND BREAK.

NO.	ITEM		CRITERIA		
		THE LCD WITH EXTENSIVE CRACK IS NOT ACCEPTABLE			
		GENERAL GLASS CHIP:	a	b	c
		b	≤ t/2	< VIEWING AREA	≤ 1/8X
		c a	$t/2 > , \le 2t$	≤ W/2	≤ 1/8X
			*W=DISTANCI	E BETWEEN	
				AREA AND LO	CD
			PANEL ED		4
			X = LCD SID		14.
		W	t = GLASS T	HICKNESS	
		, c			Y
		a			
		1			
		\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\			
		2.0		100	
) ′	
		N b			, P
		a	> 0 ^y	.15	
	\$	CORNER PART ?	a ≤ t/2	b < VIEWING AREA	c ≤ 1/8X
		\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	$> t/2$, $\leq 2t$		≤ 1/8X ≤ 1/8X
			*W=DISTANCI	E BETWEEN	
15.	CRACKED GLASS	C	K /	AREA AND LO	CD
		a	PANEL ED	OGE	
			X = LCD SID	E LENGTH	
			t = GLASS T	HICKNESS	
		<i>y</i>	• 100		
		CHIP ON ELECTRODE PAD	a	b ≤ 0.5mm	c ≤ 1/8X
		a	* X=LCD SIDE		≤ 1/8X
			t =GLASS TH		
		C C	t =OLASS II	IICIN (LOO	
			a	b	c
			≤ t	≤ 1/8X	≤L
		V5	*X=LCD SIDE		
	Ó	l'Oy	t = GLASS TH		
				DE PAD LENGT	
	63			HIPPING THE IT	
	~~			, OVER 2/3 OF T ND BE, INSPEC	
				G TO ELECTRO	
		a		SPECIFICATIO	
		7		OUCT WILL BE	
	7			THE CUSTOM	
				MENT MARK M	,
			BE DEMAGE	ED	
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13. RELIABILITY TEST

13.1 STANDARD SPECIFICATIONS FOR RELIABILITY OF LCD MODULE

NO.	ITEM	DESCRIPTION
1	HIGH TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +70°C FOR 240 HRS
2	LOW TEMPERATURE OPERATION	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -20°C FOR 240 HRS
3	HIGH TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT +80°C FOR 240 HRS
4	LOW TEMPERATURE STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT -30°C FOR 240 HRS
5	HIGH TEMPERATURE / HUMIDITY TEST STORAGE	THE SAMPLE SHOULD BE ALLOWED TO STAND AT 60°C, 90% RH 240 HRS
6	THERMAL SHOCK (NOT OPERATED)	THE SAMPLE SHOULD BE ALLOWED TO STAND THE FOLLOWING 10 CYCLES OF OPERATION: +70°C -30°C -30°C -30°C
7	ESD (ELECTROSTATIC DISCHARGE) (NOT OPERATED)	AIR DISCHARGE ± 12KV CONTACT DISCHARGE ± 8KV (ACCORDING TO IEC-61000-4-2)

NOTE (1): THE TEST SAMPLES HAVE RECOVERY TIME FOR 2 HOURS AT ROOM TEMPERATURE BEFORE THE FUNCTION CHECK. IN THE STANDARD CONDITIONS, THERE IS NO DISPLAY FUNCTION NG ISSUE OCCURRED.

13.2 TESTING CONDITIONS AND INSPECTION CRITERIA FOR THE FINAL TEST THE TESTING SAMPLE MUST BE STORED AT ROOM EMPERATURE FOR 24 HOURS, AFTER THE TESTS LISTED IN TABLE 13.2, STANDARD SPECIFICATIONS FOR RELIABILITY HAVE BEEN EXECUTED IN ORDER TO ENSURE STABILITY.

NO.	ITEM	TEST MODEL	INSPECTION CRITERIA
1	CURRENT CONSUMPTION	REFER TO SPECIFICATION	THE CURRENT CONSUMPTION SHOULD CONFORM TO THE PRODUCT SPECIFICATION.
2	CONTRAST		AFTER THE TESTS HAVE BEEN EXECUTED, THE CONTRAST MUST BE LARGER THAN HALF OF ITS INITIAL VALUE PRIOR TO THE TESTS.
3	APPEARANCE	VISUAL INSPECTION	DEFECT FREE

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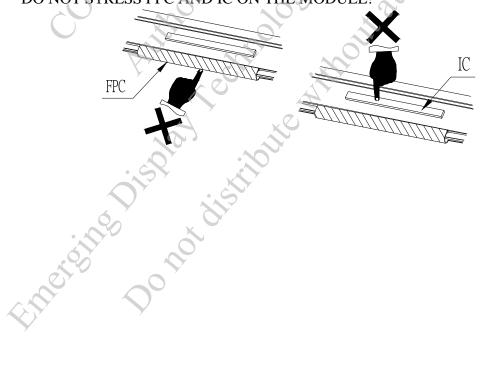
14. PRECAUTION

14.1 OPERATION

- 14.1.1 DO NOT CONNECT OR DISCONNECT MODULES TO OR FROM THE MAIN SYSTEM WHILE POWER IS BEING SUPPLIED .
- 14.1.2 USE THE MODULE WITHIN SPECIFIED TEMPERATURE; LOWER TEMPERATURE CAUSES THE RETARDATION OF BLINKING SPEED OF THE DISPLAY; HIGHER TEMPERATURE MAKES OVERALL DISPLAY DISCOLOR. WHEN THE TEMPERATURE RETURNS TO NORMALITY, THE DISPLAY WILL OPERATE NORMALLY.
- 14.1.3 ADJUST THE LC DRIVING VOLTAGE TO OBTAIN THE OPTIMUM CONTRAST .
- 14.1.4 POWER ON SEQUENCE INPUT SIGNALS SHOULD NOT BE SUPPLIED TO LCD MODULE BEFORE POWER SUPPLY VOLTAGE IS APPLIED AND REACHES THE SPECIFIED VALUE.

 IF ABOVE SEQUENCE IS NOT FOLLOWED, CMOS LSIS OF LCD MODULES MAY BE DAMAGED DUE TO LATCH UP PROBLEM.
- 14.1.5 NOT ALLOWED TO INFLICT ANY EXTERNAL STRESS AND TO CAUSE ANY MECHANICAL INTERFERENCE ON THE BENDING AREA OF FPC DURING THE TAIL BENDING BACKWARDS!

 DO NOT STRESS FPC AND IC ON THE MODULE!



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14.2 NOTICE

- 14.2.1 USE A GROUNDED SOLDERING IRON WHEN SOLDERING CONNECTOR I/O TERMINALS . FOR SOLDERING OR REPAIRING, TAKE PRECAUTION AGAINST THE TEMPERATURE OF THE SOLDERING IRON AND THE SOLDERING TIME TO PREVENT PEELING OFF THE THROUGH-HOLE-PAD
- 14.2.2 DO NOT DISASSEMBLE . EDT SHALL NOT BE HELD RESPONSIBLE IF THE MODULE IS DISASSEMBLED AND UPON THE REASSEMBLY THE MODULE FAILED.
- 14.2.3 DO NOT CHARGE STATIC ELECTRICITY, AS THE CIRCUIT OF THIS MODULE CONTAINS CMOS LSIS. A WORKMAN'S BODY SHOULD ALWAYS BE STATIC-PROTECTED BY USE OF AN ESD STRAP. WORKING CLOTHES FOR SUCH PERSONNEL SHOULD BE OF STATIC-PROTECTED MATERIAL.
- 14.2.4 ALWAYS GROUND THE ELECTRICALLY-POWERED DRIVER BEFORE USING IT TO INSTALL THE LCD MODULE. WHILE CLEANING THE WORK STATION BY VACUUM CLEANER, DO NOT BRING THE SUCKING MOUTH NEAR THE MODULE; STATIC ELECTRICITY OF THE ELECTRICALLY-POWERED DRIVER OR THE VACUUM CLEANER MAY DESTROY THE MODULE.
- 14.2.5 DON'T GIVE EXTERNAL SHOCK.
- 14.2.6 DON'T APPLY EXCESSIVE FORCE ON THE SURFACE.
- 14.2.7 LIQUID IN LCD IS HAZARDOUS SUBSTANCE. MUST NOT LICK AND SWALLOW.
 WHEN THE LIQUID IS ATTACH TO YOUR, SKIN, CLOTH ETC. WASH IT OUT THOROUGHLY AND IMMEDIATELY.
- 14.2.8 DON'T OPERATE IT ABOVE THE ABSOLUTE MAXIMUM RATING.
- 14.2.9 STORAGE IN A CLEAN ENVIRONMENT, FREE FROM DUST, ACTIVE GAS, AND SOLVENT.
- 14.2.10 STORE WITHOUT ANY PHYSICAL LOAD.
- 14.2.11 REWIRING: NO MORE THAN 3 TIMES.